

40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max (Note 9) T _C = +25°C
	3.0mΩ @ V _{GS} = 10V	100A
40V	5.0mΩ @ V _{GS} = 5V	93A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- **DC-DC Converters**
- Power Management

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching, Test in Production -Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- Excellent Q_{GD} × R_{DS(ON)} Product (FOM)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMTH43M8LFGQ)

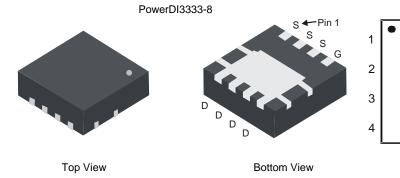
Mechanical Data

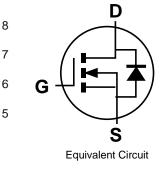
- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208@3

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Weight: 0.008 grams (Approximate)

Top View





Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH43M8LFG-7	PowerDI3333-8	2000/Tape & Reel
DMTH43M8LFG-13	PowerDI3333-8	3000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes: 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



HK8 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)

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Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	40	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Notes 6 & 9) V_{GS} = 10V	T _C = +25°C T _C = +100°C	ID	100 85	А
Continuous Drain Current (Note 5) V_{GS} = 10V	T _A = +25°C T _A = +100°C	ID	24.0 16.9	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	•	I _{DM}	400	А
Maximum Continuous Body Diode Forward Current (Note 6)	ls	3.05	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	I _{SM}	400	А	
Avalanche Current, L = 1mH	I _{AS}	18.2	А	
Avalanche Energy, L = 1mH	E _{AS}	165	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.62	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ extsf{ heta}JA}$	57.8	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	65.2	W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	2.3	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	٥°

Electrical Characteristics (@T_J = +25°C, unless otherwise specified.)

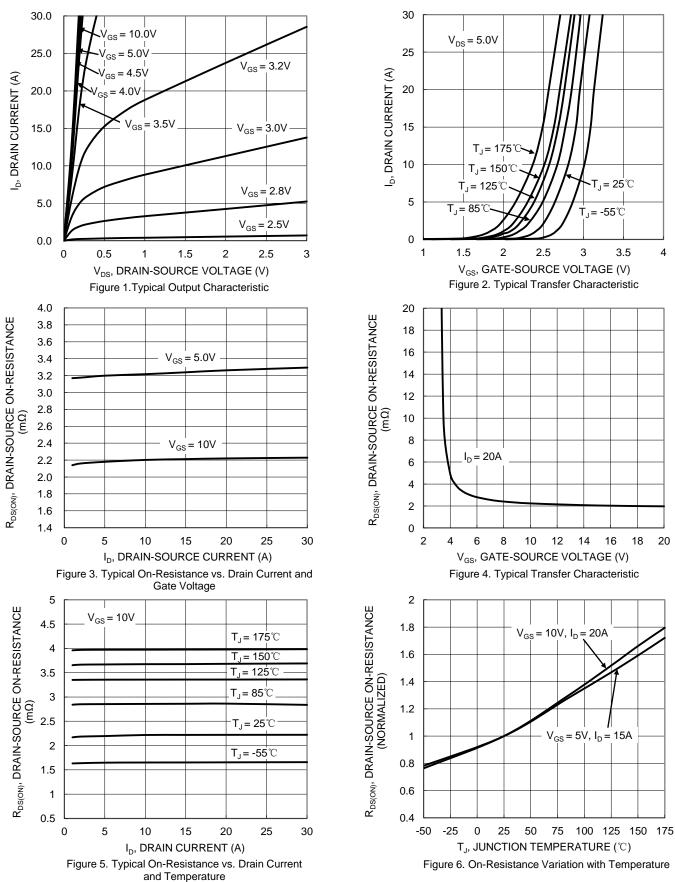
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40		—	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	—	—	1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.5	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	2.3	3.0		$V_{GS} = 10V, I_D = 20A$	
	R _{DS(ON)}	_	3.4	5.0		$V_{GS} = 5V, I_D = 15A$	
Statis Drain Source On Desistence (T. 175°C) (Note 0)	_	—		6.0	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance ($T_J = +175^{\circ}C$) (Note 8)	R _{DS(ON)}	_	-	9.0		V _{GS} = 5V, I _D = 15A	
Diode Forward Voltage	V _{SD}		0.8	1.0	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)						·	
Input Capacitance	Ciss	—	2798	—		$V_{DS} = 20V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	_	904	—	pF		
Reverse Transfer Capacitance	Crss	_	88	—			
Gate Resistance	R _G	_	2.44	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q _G	—	40.1	—		V _{DS} = 20V, I _D = 20A, V _{GS} = 10V	
Gate-Source Charge	Q _{GS}	_	5.2	—	nC		
Gate-Drain Charge	Q _{GD}		8.8	_			
Turn-On Delay Time	t _{D(ON)}	_	5.16	—		$V_{DD} = 20V, V_{GS} = 10V,$ $R_G = 1.6\Omega, I_D = 20A$	
Turn-On Rise Time	t _R		10.7	_			
Turn-Off Delay Time	t _{D(OFF)}	_	24.6	—	ns		
Turn-Off Fall Time	t _F	_	12.4	—	1		
Body Diode Reverse Recovery Time	t _{RR}	_	32.6	—	ns	1 154 1/14 1004/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	26.6	—	nC	I _F = 15A, di/dt = 100A/μs	

Notes:

Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.
Package limit.

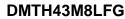


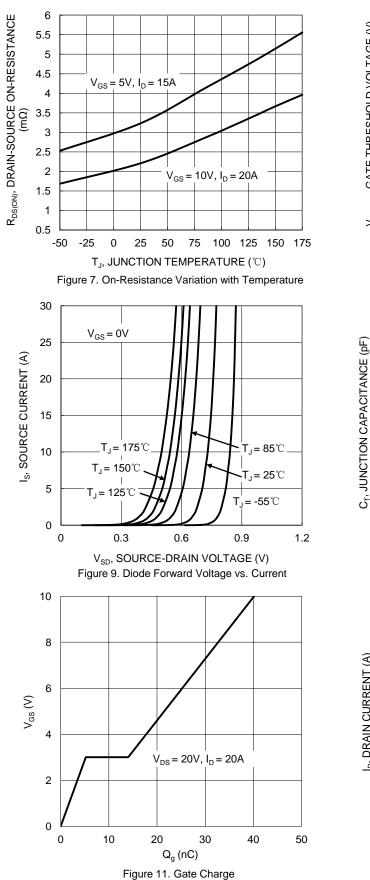
DMTH43M8LFG

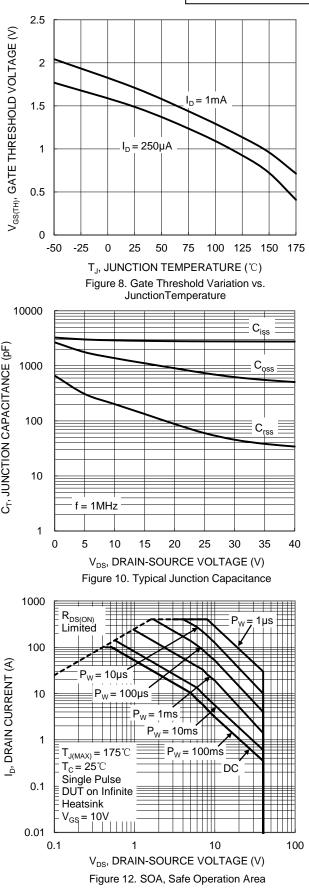


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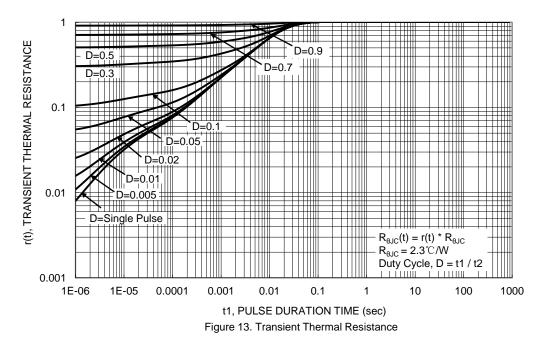






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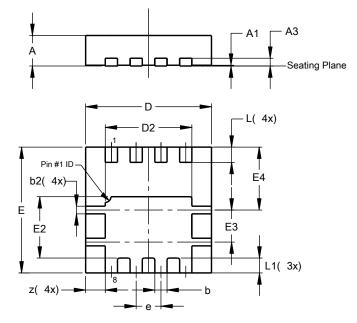




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

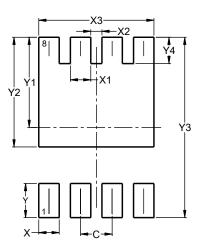


PowerDI3333-8						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	-	-	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	_	_	0.65			
L	0.35	0.45	0.40			
L1	_	-	0.39			
z	_	_	0.515			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
X3	2.370		
Y	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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